

IRF520S-VB Datasheet

N-Channel 100-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{(BR)DSS} (V)	R _{DS(on)} (Ω)	I _D (A)		
100	0.100 at V _{GS} = 10 V	20		

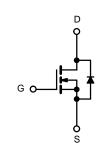
FEATURES

- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % Rg Tested

APPLICATIONS

Isolated DC/DC Converters





N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S T _C = 25 °C, unless oth	erwise noted			
Parameter	-	Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	100	- V	
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	1-	20		
	T _C = 125 °C	I _D	16		
Pulsed Drain Current		I _{DM}	70	A	
Avalanche Current	L = 0.1 mH	I _{AS}	20		
Single Pulse Avalanche Energy ^b	L = 0.1 min	E _{AS}	200	mJ	
Marian Brance Discipation b	T _C = 25 °C	р	105	14/	
Maximum Power Dissipation ^b	T _A = 25 °C ^d	– P _D –	3.75	- W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)		R _{thJC}	0.4	0/11	

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V$, $I_{D} = 250 \mu A$	100			V
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		3	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	
	I _{DSS}	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50	μA
		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 V$, $V_{GS} = 10 V$	120			А
		V _{GS} = 10 V, I _D = 20 A		0.100		
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.110		Ω
		V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C		0.120		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A	25			S
Dynamic ^b	•			•		
Input Capacitance	C _{iss}			950		pF
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		280		
Reverse Transfer Capacitance	C _{rss}			110		
Total Gate Charge ^c	Qg				28	nC
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 65 A			4.8	
Gate-Drain Charge ^c	Q _{gd}				15	
Gate Resistance	R _g		0.5	1.7	3.3	Ω
Turn-On Delay Time ^c	t _{d(on)}			8		
Rise Time ^c	t _r	V_{DD} = 100 V, R _L = 1.5 Ω		120		ns
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 65 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		25		
Fall Time ^c	t _f			50		
Source-Drain Diode Ratings and Ch	aracteristics 7	$\Gamma_{\rm C} = 25 \ {}^{\circ}{\rm C}^{\rm b}$				
Continuous Current	ا _S				65	٨
Pulsed Current	I _{SM}				140	A
Forward Voltage ^a	V _{SD}	I _F = 65 A, V _{GS} = 0 V		1.0	1.5	V
Reverse Recovery Time	t _{rr}			130	200	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, di/dt = 100 A/μs		8	12	А
Reverse Recovery Charge	Q _{rr}	1		0.52	1.2	uС

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Bsemi



- 55 °C

T_C = 125 °C

25 °C

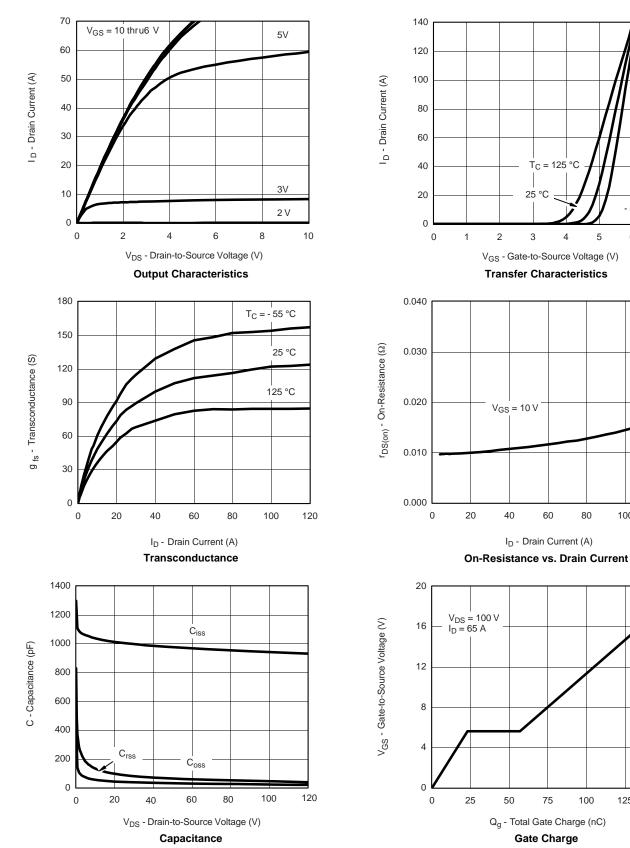
Transfer Characteristics

 $V_{GS} = 10 V$

Qg - Total Gate Charge (nC)

Gate Charge

I_D - Drain Current (A)

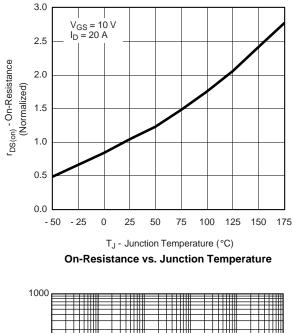


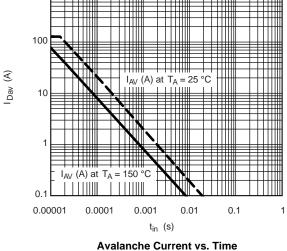
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

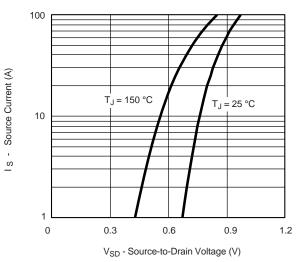
服务热线:400-655-8788



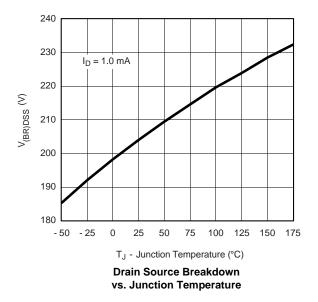
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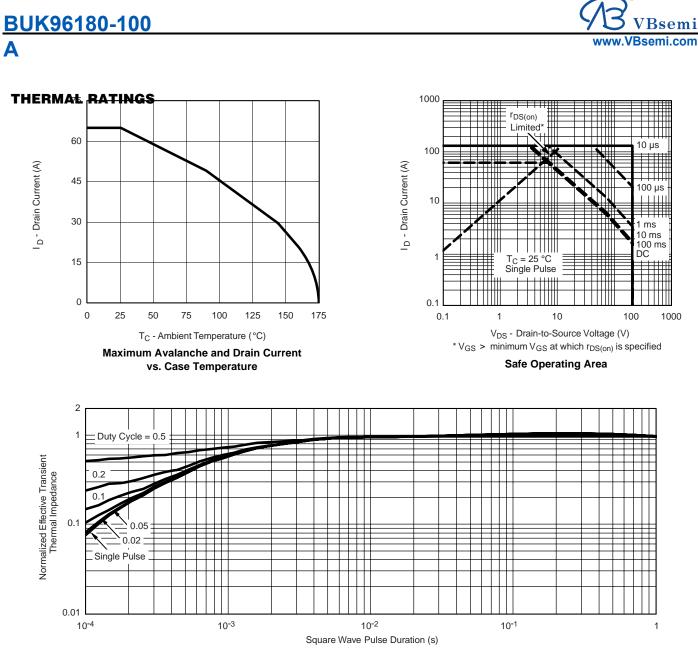






Source-Drain Diode Forward Voltage

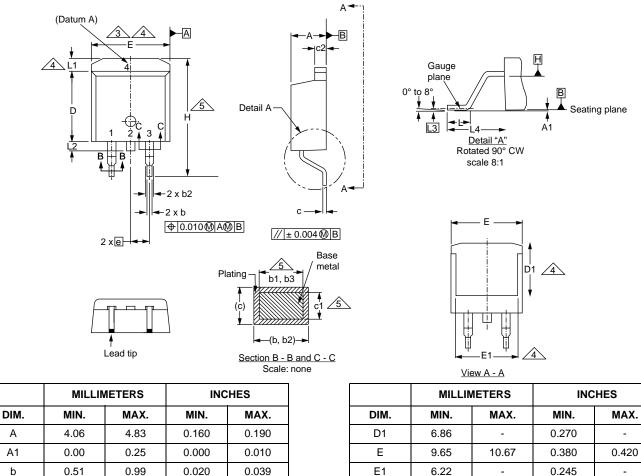




Normalized Thermal Transient Impedance, Junction-to-Case



TO-263AB (HIGH VOLTAGE)



_		
N	otas	

А

A1

b

b1

h2

b3

с

c1

c2

D

DWG: 5970

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

0.99

0.89

1.78

1.73

0.74

0.58

1.65

9.65

0.020

0.045

0.045

0.015

0.015

0.045

0.330

2. Dimensions are shown in millimeters (inches).

0.51

1.14

1.14

0.38

0.38

1.14

8.38

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0.039

0.035

0.070

0.068

0.029

0.023

0.065

0.380

- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

-

0.625

0.110

0.066

0.070

0.208

0.100 BSC

0.010 BSC

0.575

0.070

-

-

0.188

-

15.88

2.79

1.65

1.78

5.28

2.54 BSC

0.25 BSC

14.61

1.78

-

-

4.78

е

н

L

L1

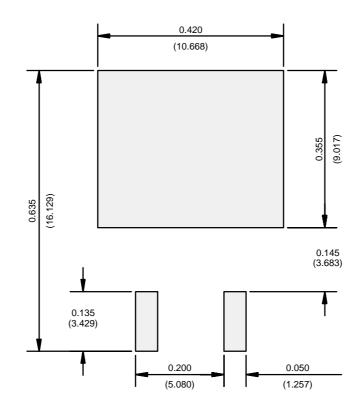
L2

L3

L4

^{3.} Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead

Recommended Minimum Pads Dimensions in Inches/(mm)



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